

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
 3) All voltages (V) and currents (A) are negative polarity for PNP transistors.

## **Thermal Characteristics** $T_{a} = 25^{\circ}C$ unless otherwise noted

Symbol	Characteristic	Мах			Units
		2N3906	*MMBT3906	**PZT3906	
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	1,000 8.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

\*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

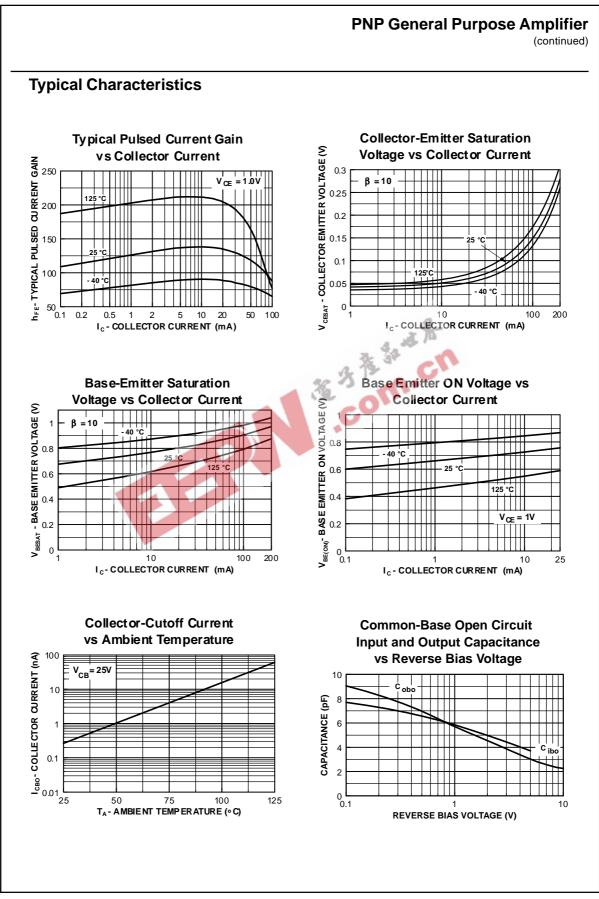
\*\* Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead min. 6 cm<sup>2</sup>.

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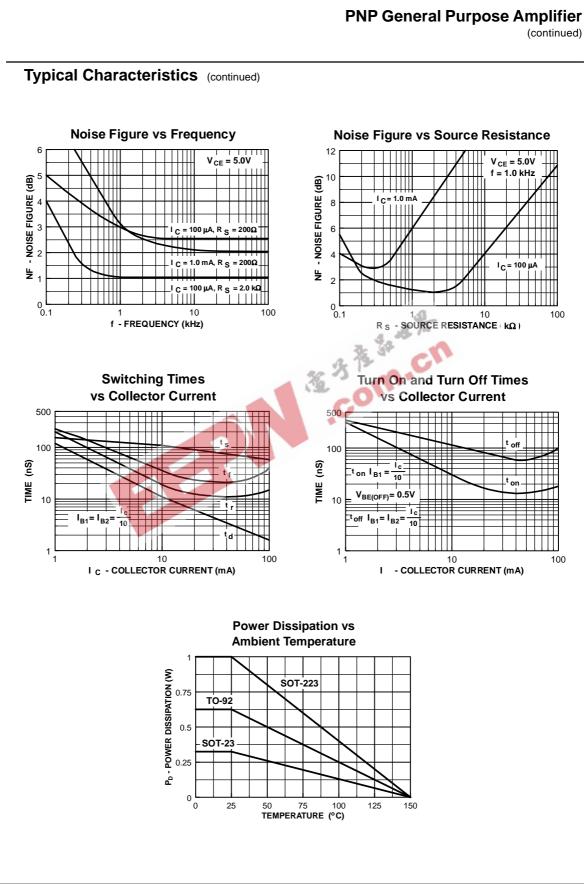
Electrical Characteristics T <sub>A</sub> = 25°C unless otherwise noted								
Symbol	Parameter	Test Conditions	Min	Мах	Units			
OFF CHAF	RACTERISTICS							
(BR)CEO	Collector-Emitter Breakdown Voltage*	$I_{\rm C} = 1.0 \text{ mA}, I_{\rm B} = 0$	40		V			
(BR)CBO	Collector-Base Breakdown Voltage	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	40		V			
(BR)EBO	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	5.0		V			
3L	Base Cutoff Current	V <sub>CE</sub> = 30 V, V <sub>BE</sub> = 3.0 V		50	nA			
CEX	Collector Cutoff Current	V <sub>CE</sub> = 30 V, V <sub>BE</sub> = 3.0 V		50	nA			
ON CHAR	ACTERISTICS DC Current Gain *	$I_{\rm C} = 0.1 \text{ mA}, V_{\rm CE} = 1.0 \text{ V}$	60					
		$ I_{C} = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V} $ $ I_{C} = 10 \text{ mA}, V_{CE} = 1.0 \text{ V} $ $ I_{C} = 50 \text{ mA}, V_{CE} = 1.0 \text{ V} $ $ I_{C} = 100 \text{ mA}, V_{CE} = 1.0 \text{ V} $	80 100 60 30	300				
/ <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_{c} = 10 \text{ mA}, I_{B} = 1.0 \text{ mA}$ $I_{c} = 50 \text{ mA}, I_{B} = 5.0 \text{ mA}$	2	0.25 0.4	V V			
/ <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	$I_{C} = 10 \text{ mA}, I_{B} = 1.0 \text{ mA}$ $I_{C} = 50 \text{ mA}, I_{B} = 5.0 \text{ mA}$	0.65	0.85 0.95	V V			
SMALL SI	GNAL CHARACTERISTICS	·co						
т	Current Gain - Bandwidth Product	$I_{C} = 10 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz	250		MHz			
Cobo	Output Capacitance	$V_{CB} = 5.0 \text{ V}, I_E = 0,$ f = 100 kHz		4.5	pF			
Pibo	Input Capacitance	$V_{EB} = 0.5 V, I_C = 0,$ f = 100 kHz		10.0	pF			
NF	Noise Figure	$I_{C}$ = 100 μA, V <sub>CE</sub> = 5.0 V, R <sub>S</sub> =1.0kΩ,f=10 Hz to 15.7 kHz		4.0	dB			
SWITCHIN	NG CHARACTERISTICS							
	Delay Time	$V_{CC} = 3.0 \text{ V}, V_{BE} = 0.5 \text{ V},$		35	ns			
	Rise Time	$I_{\rm C} = 10 \text{ mA}, I_{\rm B1} = 1.0 \text{ mA}$		35	ns			
	Storage Time	$V_{\rm CC} = 3.0 \text{ V}, I_{\rm C} = 10 \text{mA}$		225	ns			
•	Fall Time	$I_{B1} = I_{B2} = 1.0 \text{ mA}$		75	ns			

# **Spice Model**

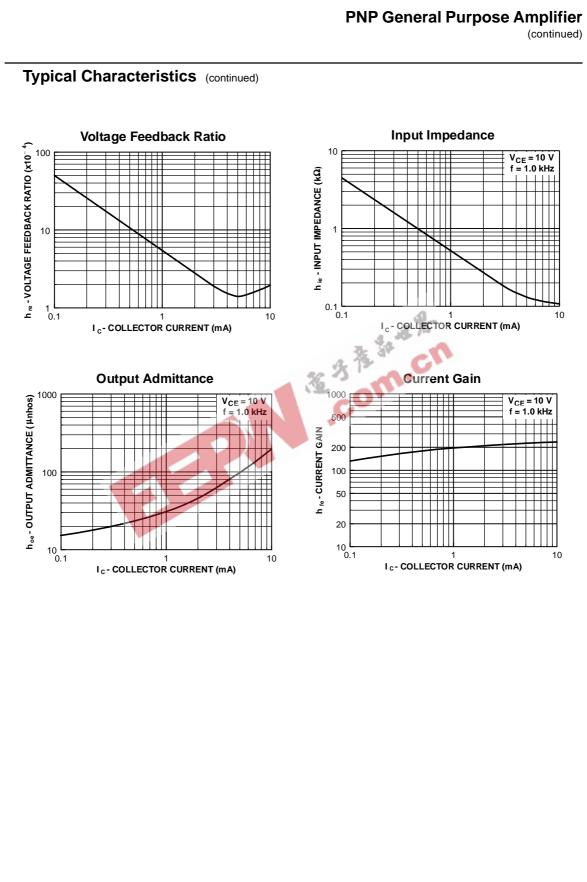
PNP (Is=1.41f Xti=3 Eg=1.11 Vaf=18.7 Bf=180.7 Ne=1.5 Ise=0 Ikf=80m Xtb=1.5 Br=4.977 Nc=2 Isc=0 Ikr=0 Rc=2.5 Cjc=9.728p Mjc=.5776 Vjc=.75 Fc=.5 Cje=8.063p Mje=.3677 Vje=.75 Tr=33.42n Tf=179.3p Itf=.4 Vtf=4 Xtf=6 Rb=10)



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FACT™	OPTOPLANAR™
FACT Quiet Series™	PACMAN™
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PowerTrench<sup>®</sup> QFET™ QS™ QT Optoelectronics<sup>™</sup> Quiet Series<sup>™</sup> SILENT SWITCHER® SMART START™ SuperSOT<sup>™</sup>-3 SuperSOT<sup>™</sup>-6 SuperSOT<sup>™</sup>-8

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